Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: **NEW ASSIGNMENT** NATURE OF CONVEYANCE: Grant of Security Interest in Patents and Trademarks

CONVEYING PARTY DATA

Name	Execution Date
Micro Component Technology, Inc.	03/29/2007

RECEIVING PARTY DATA

Name:	Laurus Master Fund, Ltd.	
Street Address:	335 Madison Ave., 10th Floor	
Internal Address:	c/o Laurus Capital Management, LLC	
City:	New Haven	
State/Country:	NEW YORK	
Postal Code:	10017	

PROPERTY NUMBERS Total: 14

Property Type	Number
Patent Number:	5966940
Patent Number:	6521853
Patent Number:	5287294
Patent Number:	4835464
Patent Number:	4866824
Patent Number:	4867296
Patent Number:	5177436
Patent Number:	6112905
Patent Number:	6234321
Patent Number:	4191196
Patent Number:	3933247
Patent Number:	2308245
Application Number:	10308245
Application Number:	10081919

PATENT

REEL: 019265 FRAME: 0285

CORRESPONDENCE DATA

Fax Number: (202)756-9299

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 8002210770

Email: matthew.mayer@thomson.com
Correspondent Name: Corporation Service Company
Address Line 1: 1133 Avenue of the Americas

Address Line 2: Suite 3100

Address Line 4: New York, NEW YORK 10036

ATTORNEY DOCKET NUMBER: CSC # 886643

NAME OF SUBMITTER: Matthew Mayer

Total Attachments: 8

source=micro_laurus_pat14#page2.tif source=micro_laurus_pat14#page3.tif source=micro_laurus_pat14#page4.tif source=micro_laurus_pat14#page5.tif source=micro_laurus_pat14#page6.tif source=micro_laurus_pat14#page7.tif source=micro_laurus_pat14#page8.tif source=micro_laurus_pat14#page9.tif

GRANT OF SECURITY INTEREST

IN PATENTS AND TRADEMARKS

THIS GRANT OF SECURITY INTEREST ("Grant"), effected as of March 29, 2007, is executed by Micro Component Technology, Inc., a Minnesota corporation (the "Grantor"), in favor of Laurus Master Fund, Ltd. (the "Secured Party").

- A. Pursuant to a Master Security Agreement dated as of February 17, 2006 (as amended, restated, ratified, reaffirmed, supplemented and/or otherwise modified from time to time, the "Security Agreement") among the Grantor, certain other Assignors (as defined in the Security Agreement), and the Secured Party, the terms and provisions of which are hereby incorporated herein as if fully set forth herein, the Grantor and the other Assignors have granted a security interest to the Secured Party in consideration of the Secured Party's agreement to provide financial accommodations to Grantor and certain of its subsidiaries.
- B. The Grantor (1) has adopted, used and is using the trademarks reflected in the trademark registrations and trademark applications in the United States Patent and Trademark Office more particularly described on <u>Schedule 1</u> annexed hereto as part hereof (the "<u>Trademarks</u>"), and (2) has registered or applied for registration in the United States Patent and Trademark Office of the patents more particularly described on <u>Schedule 2</u> annexed hereto as part hereof (the "<u>Patents</u>").
- C. The Grantor wishes to confirm its grant to the Secured Party of a security interest in all right, title and interest of the Grantor in and to the Trademarks and Patents, and all proceeds thereof, together with the business as well as the goodwill of the business symbolized by, or related or pertaining to, the Trademarks, and the customer lists and records related to the Trademarks and Patents and all causes of action which may exist by reason of infringement of any of the Trademarks and Patents (collectively, the "T&P Collateral"), to secure the payment, performance and observance of the Obligations (as that term is defined in the Security Agreement).

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged:

- 1. The Grantor does hereby further grant to the Secured Party a security interest in the T&P Collateral to secure the full and prompt payment, performance and observance of the Obligations.
- 2. The Grantor agrees to perform, so long as the Security Agreement is in effect, all acts deemed necessary or desirable by the Secured Party to permit and assist it, at the Grantor's expense, in obtaining and enforcing the Trademarks and Patents in any and all countries. Such acts may include, but are not limited to, execution of documents and assistance or cooperation in legal proceedings. The Grantor hereby appoints the Secured Party as the Grantor's attorney-infact to execute and file any and all agreements, instruments, documents and papers as the Secured Party may determine to be necessary or desirable to evidence the Secured Party's

NY564240.1 203891-10099

security interest in the Trademarks and Patents or any other element of the T&P Collateral, all acts of such attorney-in-fact being hereby ratified and confirmed.

- 3. The Grantor acknowledges and affirms that the rights and remedies of the Secured Party with respect to the security interest in the T&P Collateral granted hereby are more fully set forth in the Security Agreement and the rights and remedies set forth herein are without prejudice to, and are in addition to, those set forth in the Security Agreement. In the event that any provisions of this Grant are deemed to conflict with the Security Agreement, the provisions of the Security Agreement shall govern.
- 4. The Grantor hereby authorizes the Secured Party to file all such financing statements or other instruments to the extent required by the Uniform Commercial Code and agrees to execute all such other documents, agreements and instruments as may be required or deemed necessary by the Secured Party, in each case for purposes of affecting or continuing Secured Party's security interest in the T&P Collateral.

[REMAINDER OF PAGE INTENTIONALLY LEFT BLANK]

NY564240.1 203891-10099

IN WITNESS WHEREOF, the Grantor has caused this instrument to be executed as of the day and year first above written.

MICRO COMPONENT TECHNOLOGY, INC.

Name:

Title:

LAURUS/MASTER FUND, LTD.

C50

By:_

Name: Title: Eugene Grin Director

NY564240.1 203891-10099

3

אומית אומינון דיישות

REEL: 019265 FRAME: 0289

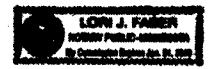
COUNTY OF PINE.

On this 30 day of March ____ 2007, before me personally came Roger

E. Cower ____ who, being by me duly sworn, did state as follows: that [s]he is _____ of Micro Component Technology, Inc. that [s]he is authorized to execute the foregoing Grant on behalf of said corporation and that [s]he did so by authority of the [Board of Directors] of said corporation.

Notary Public

4



NY564240.1 203891-10099 PATTERY'S / TEARGRAPHICS

STATE OF New York SS.:

On this 19th day of April, 2007, before me personally came <u>Eugene Grin</u> who, being by me duly sworn, did state as follows: that he is <u>Director</u> of Laurus Master Fund, Ltd.. that he is authorized to execute the foregoing Grant on behalf of said company.

Notary Public

CHARTENANTHOMAS
MOTARY PUBLIC, STATE OF NEW YORK
NO. 027116124424
CHALLFIED IN NEW YORK COUNTY
COMMISSION EXPIRES \$ 1.00 / 2000

NY564240.1 203891-10099

4

SCHEDULE 1 TO GRANT OF SECURITY INTEREST

REGISTERED TRADEMARKS AND TRADEMARK APPLICATIONS

<u>Trademark</u>	Registration or Application Number	Registration or Application Date	Country	<u>Status</u>
Tapestry	2,655,429	12/03/2002	USA	Registered
SmartTrak	2,703,499	04/08/2003	USA	Registered
SmartMark	2,705,844	04/15/2003	USA	Registered
SmartSort	2,705,843	04/15/2003	USA	Registered
MCT 3120	1,514,458	11/29/1988	USA	Registered
MCT	1,118,129	05/15/1979	USA	Registered

NY564240.1 203891-10099

PATENT

REEL: 019265 FRAME: 0292

Schedule 2

PATENT SCHEDULE

<u>Patent</u>	Registration or Application Number	Registration or Application Date
Semiconductor Thermal Conditioning Apparatus and Method	08/972,312 U.S. Pat. No. 5,966,940	11/18/1997 10/19/1999
Method and Apparatus for Sorting Semiconductor Devices	09/566,458 U.S. Pat. No. 6,521,853	05/08/2000 02/18/2003
Apparatus and Method for Automatically Calibrating for Temperature and Input Tray on an Integrated Circuit Handler	07/702.945 U.S. Pat. No. 5,287,294	05/20/1991 02/15/1994
Decoupling Apparatus for Use with Integrated Circuit Tester	07/145,668 U.S. Pat. No. 4,835,464	01/14/1988 05/30/1989
Centering Mechanism	07/178,842 U.S. Pat. No. 4,866,824	04/06/1988 09/19/1989
Precision Alignment Device	07/127,444 U.S. Pat. No. 4,867,296	12/02/1987 09/19/1989
Contractor for Testing Integrated Circuit chips Mounted in Molded Carrier Rings	07/703,604 U.S. Pat. No. 5,177,436	05/21/1991 01/05/1993
Automatic Semiconductor Part Handler	08/678,426 U.S. Pat. No. 6,112,905	07/31/1996 09/05/2000
Automatic Semiconductor Part Handler	09/535,869 U.S. Pat. No. 6,234,321	03/27/2000 05/22/2001
Profilometry method and apparatus	05/696318 4191196	
High speed magnetic core handler	05/424701 3933247	

NY568745.1 203891-10099

#12	NOT AVAILABLE	2308245	
#13	Method and apparatus for sorting semiconductor devices	10308245	12/02/2002
#14	Singulation apparatus and method for manufacturing semiconductors	10081919	02/20/2002

NY568745.1 203891-10099

RECORDED: 05/09/2007